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PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Docket No: Q76605

Takayasu KOMATSU, et al.

Appln. No.: 10/621,382

Group Art Unit: 1756

Confirmation No.: 4041

Examiner: Nicole M. Barreca

Filed: July 18, 2003

For:

ETCHING SUBSTRATE MATERIAL, ETCHING PROCESS, AND ARTICLE

OBTAINED BY ETCHING

PETITION FOR EXTENSION OF TIME UNDER 37 C.F.R. § 1.136

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Pursuant to 37 C.F.R. § 1.136, Applicant hereby petitions for an extension of time of three months, extending the time for responding to the Office Action of May 20, 2005 to November 20, 2005.

A check for the statutory fee of \$1,020.00 is attached. The USPTO is directed and authorized to charge all required fees, except for the Issue Fee and the Publication Fee, to Deposit Account No. 19-4880. Please also credit any overpayments to said Deposit Account. A duplicate copy of this sheet is enclosed.

11/22/2005-NDANTE1--00000024-10621382-----

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Respectfully submitted,

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Date: November 18, 2005

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